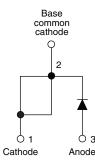


Vishay Semiconductors

HEXFRED[®] Ultrafast Soft Recovery Diode, 30 A







PRODUCT SUMMARY						
Package	TO-247AC modified (2 pins)					
I _{F(AV)}	30 A					
V _R	1200 V					
V _F at I _F	4.1 V					
t _{rr} typ.	47 ns					
T _J max.	150 °C					
Diode variation	Single die					

FEATURES

- Ultrafast and ultrasoft recovery
- Very low I_{RRM} and Q_{rr}
- Designed and qualified according to JEDEC-JESD47
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

BENEFITS

- Reduced RFI and EMI
- · Reduced power loss in diode and switching transistor
- Higher frequency operation
- Reduced snubbing
- Reduced parts count

DESCRIPTION

VS-HFA30PB120... is a state of the art center tap ultrafast recovery diode. Employing the latest in epitaxial construction and advanced processing techniques it features a superb combination of characteristics which result in performance which is unsurpassed by any rectifier previously available. With basic ratings of 1200 V and 30 A continuous current, the VS-HFA30PB120... is especially well suited for use as the companion diode for IGBTs and MOSFETs. In addition to ultrafast recovery time, the HEXFRED® product line features extremely low values of peak recovery current (I_{RRM}) and does not exhibit any tendency to "snap-off" during the t_b portion of recovery. The HEXFRED features combine to offer designers a rectifier with lower noise and significantly lower switching losses in both the diode and the switching transistor. These HEXFRED advantages can help to significantly reduce snubbing, component count and heatsink sizes. The HEXFRED VS-HFA30PB120... is ideally suited for applications in power supplies and power conversion systems (such as inverters), motor drives, and many other similar applications where high speed, high efficiency is needed.

ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Cathode to anode voltage	V _R		1200	V		
Maximum continuous forward current	I _F	T _C = 100 °C	30			
Single pulse forward current	I _{FSM}		120	А		
Maximum repetitive forward current	I _{FRM}		90			
Maximum power discinction	P _D	T _C = 25 °C	350	W		
Maximum power dissipation		T _C = 100 °C	140	vv		
Operating junction and storage temperature range	T _J , T _{Stg}		- 55 to + 150	°C		

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RoHS

COMPLIANT

HALOGEN

FREE



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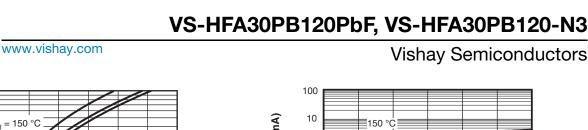
ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Cathode to anode breakdown voltage	V _{BR}	I _R = 100 μA		1200	-	-	
		I _F = 30 A		-	2.4	4.1	V
Maximum forward voltage	V _{FM}	I _F = 60 A	See fig. 1	-	3.1	5.7	
		I _F = 30 A, T _J = 125 °C		-	2.3	4.0	
Maximum reverse		$V_{R} = V_{R}$ rated	See fig. 2	-	1.3	40	
leakage current	I _{RM}	$T_J = 125 \ ^\circ C, V_R = 0.8 \ x \ V_R$ rated	See fig. 2	-	1100	4000	μA
Junction capacitance	CT	V _R = 200 V	See fig. 3	-	50	75	pF
Series inductance	L _S	Measured lead to lead 5 mm from body	package	-	8.0	-	nH

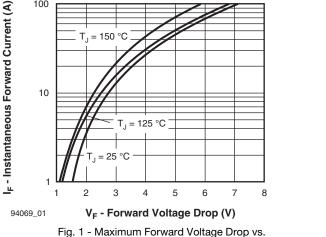
DYNAMIC RECOVERY CHARACTERISTICS ($T_J = 25 \text{ °C}$ unless otherwise specified)								
PARAMETER	SYMBOL	TEST CO	NDITIONS	MIN.	TYP.	MAX.	UNITS	
	t _{rr}	$I_F = 1.0 \text{ A}, \text{ d}I_F/\text{d}t = 200$) A/µs, V _R = 30 V	-	47	-		
Reverse recovery time See fig. 5, 10	t _{rr1}	T _J = 25 °C	I _F = 30 A	-	110	170	ns	
	t _{rr2}	T _J = 125 °C		-	170	260		
Peak recovery current See fig. 6	I _{RRM1}	T _J = 25 °C		-	10	15	А	
	I _{RRM2}	T _J = 125 °C		-	16	24	A	
Reverse recovery charge	Q _{rr1}	T _J = 25 °C	$dI_F/dt = 200 A/\mu s$	-	650	980	nC	
See fig. 7	Q _{rr2}	T _J = 125 °C	V _R = 200 V	-	1540	2310	ne	
Peak rate of fall of recovery current during t _b	dl _{(rec)M} /dt1	T _J = 25 °C		-	270	-	A∕µs	
See fig. 8	dl _{(rec)M} /dt2	T _J = 125 °C		-	240	-	λγμs	

THERMAL - MECHANICAL SPECIFICATIONS							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Lead temperature	Tlead	0.063" from case (1.6 mm) for 10 s	-	-	300	°C	
Thermal resistance, junction to case	R _{thJC}		-	-	0.36		
Thermal resistance, junction to ambient	R _{thJA}	Typical socket mount	-	-	80	°C/W	
Thermal resistance, case to heatsink	R _{thCS}	CS Mounting surface, flat, smooth and greased		0.50	-		
Weight			-	5.61	-	g	
vveigni			-	0.198	-	oz.	
Mounting torque			6.0 (5.0)	-	12 (10)	kgf · cm (lbf · in)	
Marking device		Case style TO-247AC modified (JEDEC)		HFA30	PB120		

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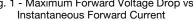
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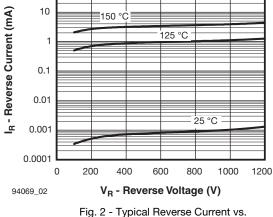


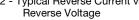


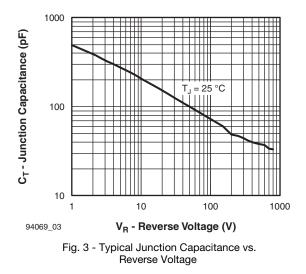
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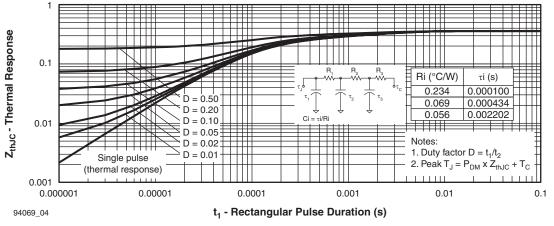
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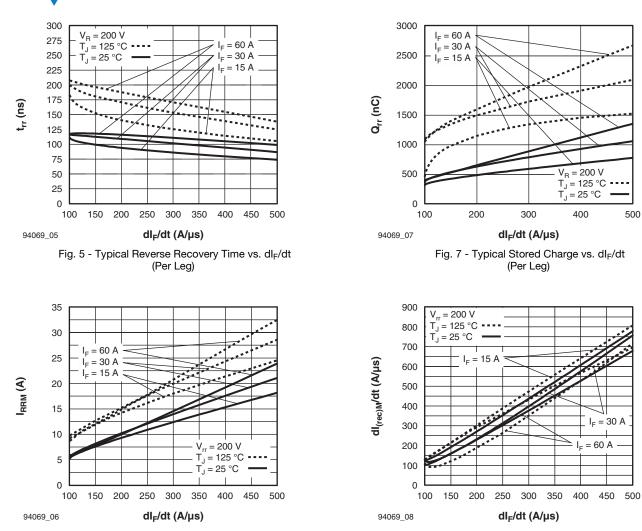


Fig. 6 - Typical Recovery Current vs. dl_F/dt (Per Leg)



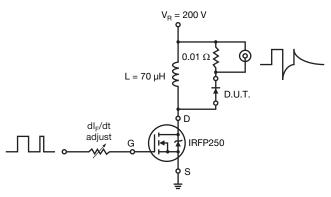


Fig. 9 - Reverse Recovery Parameter Test Circuit

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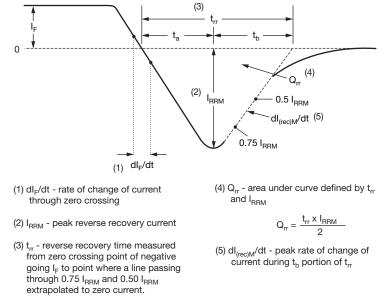


Fig. 10 - Reverse Recovery Waveform and Definitions

ORDERING INFORMATION TABLE

HF	Α	30	РВ	120	PbF		
2	3	4	5	6	7		
 Vishay Semiconductors product HEXFRED[®] family Electron irradiated Current rating (30 = 30 A) PB = TO-247AC modified Voltage rating: (120 = 1200 V) 							
 7 - Environmental digit: PbF = Lead (Pb)-free and RoHS-compliant 							

-N3 = Halogen-free, RoHS-compliant and totally lead (Pb)-free

ORDERING INFORMATION (Example)						
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION			
VS-HFA30PB120PbF	25	500	Antistatic plastic tube			
VS-HFA30PB120-N3	25	500	Antistatic plastic tube			

LINKS TO RELATED DOCUMENTS					
Dimensions		www.vishay.com/doc?95541			
Dort marking information	TO-247AC modified PbF	www.vishay.com/doc?95255			
Part marking information	TO-247AC modified -N3	www.vishay.com/doc?95442			
SPICE model		www.vishay.com/doc?95358			

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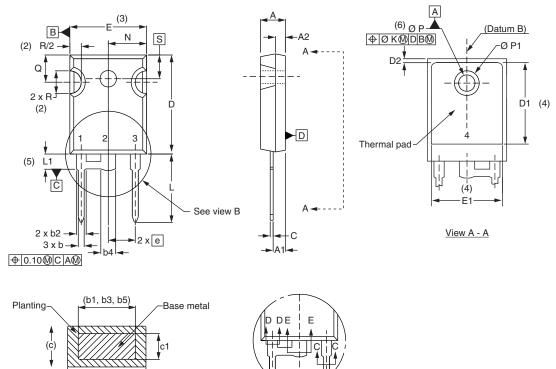
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TO-247 modified

DIMENSIONS in millimeters and inches



Section C - C, D - D, E - E

(4)

(b b2 b4)

View	В

SYMBOL	MILLIN	LLIMETERS INCHES		NOTES	
STIVIBOL	MIN.	MAX.	MIN.	MAX.	NOTES
А	4.65	5.31	0.183	0.209	
A1	2.21	2.59	0.087	0.102	
A2	1.17	1.37	0.046	0.054	
b	0.99	1.40	0.039	0.055	
b1	0.99	1.35	0.039	0.053	
b2	1.65	2.39	0.065	0.094	
b3	1.65	2.33	0.065	0.092	
b4	2.59	3.43	0.102	0.135	
b5	2.59	3.38	0.102	0.133	
С	0.38	0.89	0.015	0.035	
c1	0.38	0.84	0.015	0.033	
D	19.71	20.70	0.776	0.815	3
D1	13.08	-	0.515	-	4

SYMBOL	MILLIN	IETERS	INCHES		NOTES
STIVIDOL	MIN.	MAX.	MIN.	MAX.	NOTES
D2	0.51	1.35	0.020	0.053	
E	15.29	15.87	0.602	0.625	3
E1	13.46	-	0.53	-	
е	5.46 BSC		0.215	BSC	
ØК	0.2	254	0.010		
L	14.20	16.10	0.559	0.634	
L1	3.71	4.29	0.146	0.169	
Ν	7.62	7.62 BSC		.3	
ØΡ	3.56	3.66	0.14	0.144	
Ø P1	-	7.39	-	0.291	
Q	5.31	5.69	0.209	0.224	
R	4.52	5.49	0.178	0.216	
S	5.51	BSC	0.217	' BSC	

Notes

- ⁽¹⁾ Dimensioning and tolerance per ASME Y14.5M-1994
- (2) Contour of slot optional
- ⁽³⁾ Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- $^{\rm (4)}\,$ Thermal pad contour optional with dimensions D1 and E1
- ⁽⁵⁾ Lead finish uncontrolled in L1
- ⁽⁶⁾ Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- $^{(7)}$ Outline conforms to JEDEC $^{\tiny (\! R \!)}$ outline TO-247 with exception of dimension c and Q

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